## TECHNICAL INFORMATION

FOR PANEL AND PCB SWITCHES

## SPECIFICATIONS

Dimensions, specifications and data shown in this catalog are subject to change without notice. Consequently, they are not contractual in any way. Electrical, mechanical and endurance specifications are based upon in-house tests made by APEM. These tests are conducted using internationally recognized procedures. In the event of a product being used under different conditions, the user must ensure the products suitability for use under those conditions. Incorrect storage, handling, operation or application of the product may result in damage to the product or equipment. The negative value indicated under "Operating temperature" is given for normal usage conditions (products free of moisture, which could generate frost or ice and block the mechanism).
The specifications give the technical performances of the switches. If the equipment on which our products are mounted is submitted to safety standards, the customer should select approved models or models conforming to the standards (marked CE only). Consult factory for details of models that can be marked CE.

## DRAWINGS

Products are shown with their standard actuator (for other actuators, see options).
Scale : drawings in this catalog are to different scales: request data sheet if you need other dimensions for a specific part number.

## TOLERANCES

Unless otherwise specified, the general tolerance for dimensions in this catalog is $\pm 0,3$ (.012). Overall dimension tolerance is $\pm 0,5$ (.020). Request data sheet for further information.

## SOLDERING CONDITIONS

Recommendation concerning the conditions of hand soldering with lead-free alloy solder wire type SAC 305 (flux amount 2,2\%): temperature $337-381^{\circ} \mathrm{C}$.
An application time too long can damage the parts of the product in contact with the soldering lug. Standard application time is 3s.

## SEALING OF TERMINALS

Due to the new generations of active flux, epoxy sealing of terminals is preferred to prevent any risk of switch contamination.

## ROHS II COMPLIANCE

The RoHS directive 2011/65/EC of the European parliament and of the Council of June 8, 2011 restricts the use of certain hazardous substances in electrical and electronic equipment: Mercury ( Hg ), Cadmium (Cd), Hexavalent Chrome (Cr+6), Polybrominated biphenyls (PBB) and Polybrominated diphenyl ethers (PBDE including decaBDE), Lead (Pb). There is no change of part number for RoHS compliant products. Some specific products or options can still be supplied in nonRoHS version with customer's agreement.

Standard products manufactured by APEM are already and will remain in compliance with the restriction of the marketing and use of the above mentioned substances imposed by such directive.

Switches for printed circuit boards with tin/lead plated terminals (SnPb) have been replaced by components with pure tin plating.

For specific options using LED illumination, wires are soldered with lead-free solder.

## TECHNICAL INFORMATION

## Contacts and ratings

## CONTACT MATERIALS

Several contact technologies are available depending on models :

## FOR MINIATURE SWITCHES

|  | > End contacts : silver. |
| ---: | :--- |
| A | > Center contacts and terminals : brass, silver plated. |
|  | > For high ratings at $125 \mathrm{VAC}-250 \mathrm{VAC}$ or over 0,1A |
|  | 30 VDC (levels III and IV). |
|  | > End contacts : silver with gold plating over nickel |
|  | barrier. |
|  | > Center contacts and terminals : brass, gold plated. |
| AD | > For low level applications (levels I and II). |
|  | > Can be used for high ratings (level IV), the gold |
|  | layer being considered only as a protection against |
|  | oxidation during storage. |
|  | > Contacts and terminals : brass with gold plating |
| CD over nickel barrier. |  |

## FOR INDUSTRIAL SWITCHES

, End contacts : silver rivet or silver inlay.
A
> If not specified in model number, the contact material is indicated in the specifications of each series.

C
, Silver plated copper or brass.

Silver cadmium oxide contacts (S) available on the 4000 $-600 \mathrm{H}-600 \mathrm{NH}$ and 2600 series, can be replaced by silver tin oxyde contacts.

## HIGH INRUSH CURRENTS

Special contact materials and switch constructions allow particularly high inrush currents to be taken by some models of the 5000,11000 and 12000 series.

## ELECTRICAL LEVELS

STANDARD MINIATURE SWITCHES


## Recommended contacts

Level I : very low level Telecommunications $\mathrm{D}, \mathrm{AD}$ or CD contacts Level II : low level General electronic applications D, AD or CD contacts

Level III : intermediate level Low voltage
Electric appliances
A or AD contacts
Level IV:
Mains power supply A contact

INDUSTRIAL SWITCHES - SILVER CONTACTS


The above curves feature all the ratings available in our product range. Hatched areas show minimum ratings. Maximum ratings are indicated in the specifications of each series. Note that max. current is given for standard life expectancy. For specific applications, higher currents can be applied, resulting in reduced life expectancy and vice-versa. Consult factory.

## LOW CURRENT OR DRY CIRCUIT (LEVEL I)

The quality of the gold plating (hardness, porosity, adherence) and the design of the contacts (pressure or sliding contact) allow the use of very low currents down to $10 \mu \mathrm{~A} 5 \mathrm{~V}$ or 10 mA 50 mV depending on models, measurable according to IEC 512-2, test 2a.

# TECHNICAL INFORMATION 

Positions and connections for 3-way switches • Function 4

## MINIATURE SWITCHES

5000 and 7000 series are available with CT or TH connections.
Desired connections are to be specified in enlarged box of model structure. 12000 and S series are available with TH connections only.

Model structure 5000 and 7000 series

MODEL POLES $\vdots$ TERMINALS : MOMENTARY $\begin{array}{ll}\vdots & \text { TERMINALS } \\ \text { ELECTRICAL } & \vdots \\ \text { CONNECTIONS } & \text { (1R OR 2R) }\end{array}$ FUNCTIONS (CT OR TH)

FUNCTION 4 - TYPE TH (PREFERRED) - 5000-7000-12000-S - SR SERIES


TH
E: input
S : output

FUNCTION 4 - TYPE CT (REVERSED) - 5000-7000 SERIES


Single pole switches in a double pole case Double pole switches in a four pole caseSP [-.] DP
(1) Dotted line between poles: jumper to be wired by the user.

INDUSTRIAL SWITCHES : 600 600H-3600NF - 6000 AND 2600 SERIES


## TECHNICAL INFORMATION

## Switches for peak currents

- For switching power supplies, DC-DC converters, motors...
- Peak current with 125/250VAC according to IEC 1058 (Fig 1) and direct current 60VDC (Fig 2)
- 2 maintained positions


## TESTING CIRCUIT AC VOLTAGE

Figure 1



TESTING CIRCUIT DC VOLTAGE



See 11000 and 12000 series, special option X910.

## TECHNICAL INFORMATION

## Degrees of protection : IP and IK codes

The degree of protection is indicated by 2 letters and 2 numbers.
IP•• degree of protection provided by the enclosures of electric appliances according to IEC 60529 and DIN 40050.
IK.•• degree of protection provided by the enclosures of electric appliances against external mechanical impacts according to EN 62262.

## Example: IP 65



1ST NUMBER : PROTECTION AGAINST INGRESS OF SOLID OBJECTS

| IP | TESTS | Non-protected |
| :---: | :---: | :---: |

For an additional protection of switches used in harsh environments against sand, frost or other contaminants that may cause switch failure, we recommend the use of sealing boots.

2ND NUMBER:
PROTECTION AGAINST LIQUIDS
Non-protected
Protected against vertically
falling water drops

## SEALING IP69K



High pressure, high temperature wash down

## IP69K test conditions

. Pressure : 80-120 bars
. Distance : 15 cm
. Temperature : $80^{\circ} \mathrm{C} \pm 5^{\circ} \mathrm{C}$
. Flow : 14-16 I/mn
Duration : 30 seconds per position
Illustration : PBA series switch.
(1) - One-piece bushing
(2) - Epoxy sealed terminals
(3) - O-ring

## TECHNICAL INFORMATION

## Surface mount

- The wave soldering profile is given as an indication, it does not commit APEM. Each application must be subject to specific validation by the customer.


## TYPICAL SMT REFLOW PROFILE

The PC board, carried by a conveyor belt, goes through the different areas of a reflow soldering oven:

- pre-heating (maximum $170^{\circ} \mathrm{C}, 60$ secs)
- reflow peak (maximum $245^{\circ} \mathrm{C}$ )
- final cleaning (optional)



## BOARD REWORK TECHNIQUE

Hot air reflow technique is preferred. Avoid use of a traditional soldering iron. Caution : Excessive and/or repeated high temperature exposure may affect
 switch performance and reliability.

## TYPICAL LEAD-FREE SMT REFLOW PROFILE

Complying with the ROHS directive.

| Example of Pb -free profile requirements for soldering heat resistance |  |  |
| :---: | :---: | :---: |
| Parameter | Reference | Specification (small case) |
| Temperature gradient in preheating |  | $3^{\circ} \mathrm{C} / \mathrm{s}$ max. |
| Soak time | tsoak | 2-3 minutes |
| Time above $217^{\circ} \mathrm{C}$ | t1 | 60-150 seconds |
| Time within $5^{\circ} \mathrm{C}$ of actual peak temperature | t3 | 20-40 seconds |
| Peak temperature in reflow | Tpeak | $260^{\circ} \mathrm{C}\left(+0 /-5^{\circ} \mathrm{C}\right)$ |
| Temperature gradiant in cooling |  | $6^{\circ} \mathrm{C} /$ second max. |
| Time $25^{\circ} \mathrm{C}$ to peak temperature |  | 8 minutes max. |



